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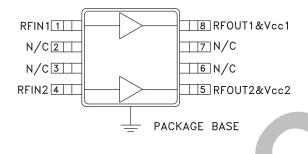
SiGe HBT DUAL CHANNEL GAIN BLOCK MMIC AMPLIFIER. DC - 5 GHz

Typical Applications

The HMC471MS8G / HMC471MS8GE is a dual BF/IF gain block & LO or PA driver:

- Cellular / PCS / 3G
- Fixed Wireless & WLAN
- CATV, Cable Modem & DBS
- Microwave Radio & Test Equipment

Functional Diagram



Features

P1dB Output Power: +20 dBm Gain: 20 dB Output IP3: +34 dBm Supply (Vs): +6V to +12V 14.9 mm² Ultra Small 8 Lead MSOP

General Description

The HMC471MS8G & HMC471MS8GE are SiGe HBT Dual Channel Gain Block MMIC SMT amplifiers covering DC to 5 GHz. These versatile products contain two gain blocks, packaged in a single 8 lead plastic MSOP, for use as either separate cascadable 50 Ohm RF/IF gain stages, LO or PA drivers or with both amplifiers combined utilizing external 90° hybrids to create a high linearity driver amplifier. Each amplifier in the HMC471MS8G(E) offers 20 dB of gain, +20 dBm P1dB with a +34 dBm output IP3 at 850 MHz while requiring only 80 mA from a single positive supply. The combined dual amplifier circuit delivers up to +21 dBm P1dB with +36 dBm OIP3 for specific application bands through 4 GHz.

Parameter Min Тур. Max Units DC - 1.0 GHz 18.5 21 dB 1.0 - 2.0 GHz 15.5 17.5 dB Gain 2.0 - 3.0 GHz 13 15 dB 3.0 - 4.0 GHz 10.5 12.5 dB 4.0 - 5.0 GHz 8 10 dB Gain Variation Over Temperature DC - 5 GHz 0.008 0.012 dB/ °C DC - 2.0 GHz 12 dB Input Return Loss 2.0 - 4.0 GHz 14 dB 4.0 - 5.0 GHz dB 8 DC - 1.0 GHz 13 dB 1.0 - 2.0 GHz 9 dB Output Return Loss 2.0 - 4.0 GHz 7 dB 4.0 - 5.0 GHz dB 5 **Reverse Isolation** DC - 5 GHz 20 dB 0.5 - 1.0 GHz 16 19 dBm 10 - 20 GHz 14 17 dBm Output Power for 1 dB Compression (P1dB) 11 2.0 - 3.0 GHz 14 dBm 30-40 GHz 9 12 dBm 4.0 - 5.0 GHz 7 10 0.5 - 1.0 GHz 34 dBm 1.0 - 2.0 GHz 32 dBm Output Third Order Intercept (IP3) 20-30 GHz 27 dBm (Pout= 0 dBm per tone, 1 MHz spacing) 3.0 - 4.0 GHz 25 dBm dBm 4.0 - 5.0 GHz 22 DC - 4 GHz 3.25 dB Noise Figure 4.0 - 5.0 GHz 4.0 dB Supply Current (Icg) 80 mΑ

Note: Data taken with broadband bias tee on device output. All specifications refer to a single amplifier.

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For price, delivery, and to place orders: Analog Devices, Inc., One Technology Way, P.O. Box 9106, Norwood, MA 02062-9106 Phone: 781-329-4700 • Order online at www.analog.com Application Support: Phone: 1-800-ANALOG-D

Electrical Specifications, Vs= 8.0 V, Rbias= 39 Ohm, T_{A} = +25° C



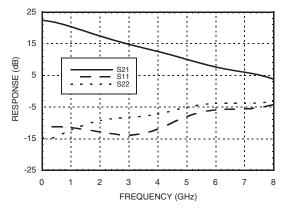
BLOCK MMIC AMPLIFIER, DC - 5 GHz

SiGe HBT DUAL CHANNEL GAIN

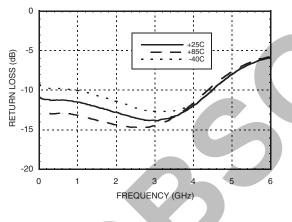
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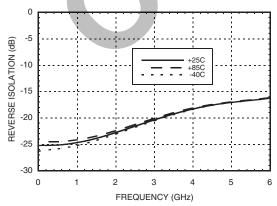
Broadband Gain & Return Loss



Input Return Loss vs. Temperature



Reverse Isolation vs. Temperature

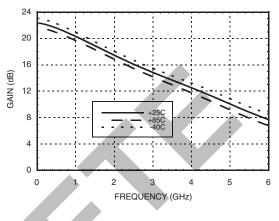


Data shown is of a single amplifier.

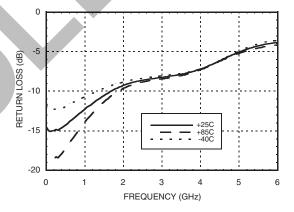
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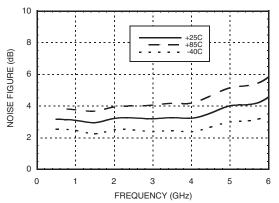
Gain vs. Temperature



Output Return Loss vs. Temperature



Noise Figure vs. Temperature



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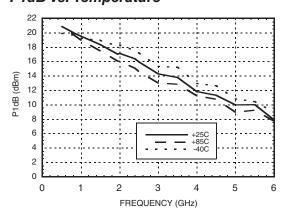
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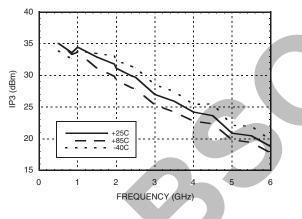
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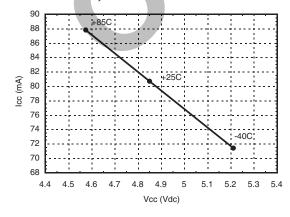
P1dB vs. Temperature



Output IP3 vs. Temperature

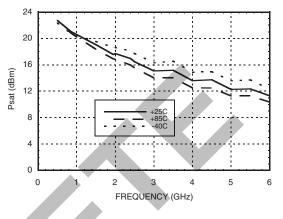


Vcc vs. Icc Over Temperature for Fixed Vs= 8V, RBIAS= 51 Ohms

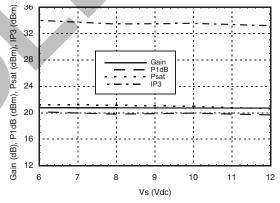


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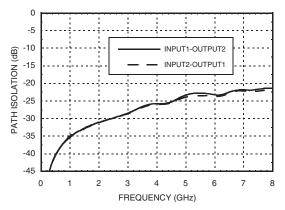
Psat vs. Temperature



Gain, Power & OIP3 vs. Supply Voltage for Constant Icc= 80 mA @ 850 MHz



Cross Channel Isolation



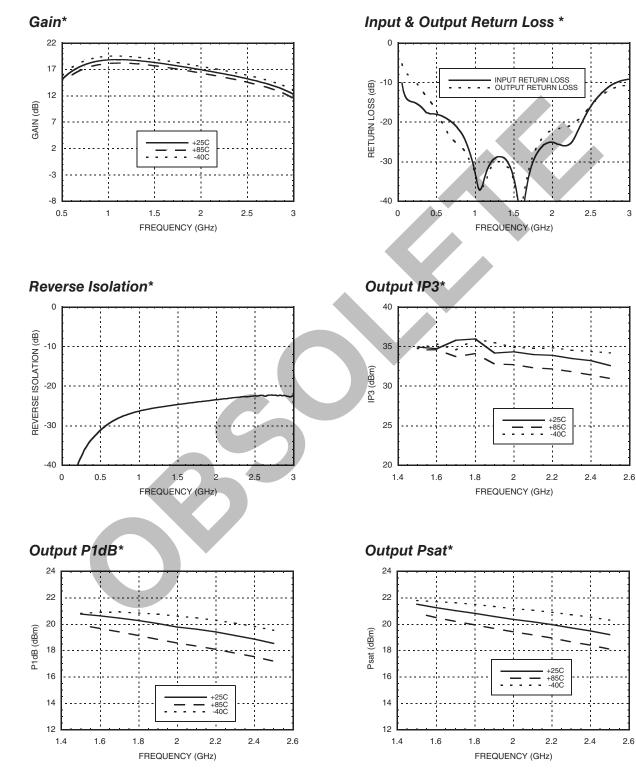
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DRIVER & GAIN BLOCK AMPLIFIERS - SMT

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* Measurements shown are of both channels with 1.5 - 2.5 GHz 90° splitter/combiners on input & output (see application circuit for balanced operation).

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SiGe HBT DUAL CHANNEL GAIN **BLOCK MMIC AMPLIFIER, DC - 5 GHz**

Absolute Maximum Ratings

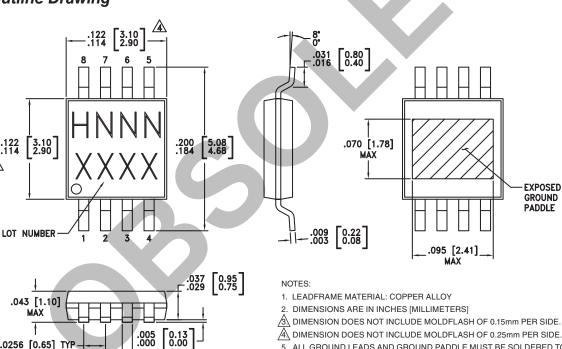
Collector Bias Voltage (Vcc)	+6.0 Vdc	
Collector Bias Current (Icc)	100 mA	
RF Input Power (RFIN)(Vcc = +4.2 Vdc)	+14 dBm	
Junction Temperature	150 °C	
Continuous Pdiss (T = 85 °C) (derate 32.6 mW/°C above 85 °C)	2.12 W	
Thermal Resistance (junction to ground paddle)	30.7 °C/W	
Storage Temperature	-65 to +150 °C	
Operating Temperature	-40 to +85 °C	
ESD Sensitivity (HBM)	Class 1A	

Outline Drawing

.122 .114

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A DIMENSION DOES NOT INCLUDE MOLDFLASH OF 0.25mm PER SIDE. 5. ALL GROUND LEADS AND GROUND PADDLE MUST BE SOLDERED TO PCB RF GROUND

Package Information

.0256 [0.65] TYP

.015 0.38 .009 0.22

TYP

Part Number	Package Body Material	Lead Finish	MSL Rating	Package Marking [3]
HMC471MS8G	Low Stress Injection Molded Plastic	Sn/Pb Solder	MSL1 ^[1]	H471 XXXX
HMC471MS8GE	RoHS-compliant Low Stress Injection Molded Plastic	100% matte Sn	MSL1 ^[2]	<u>H471</u> XXXX

[1] Max peak reflow temperature of 235 °C

[2] Max peak reflow temperature of 260 °C

[3] 4-Digit lot number XXXX

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Pin Descriptions

Pin Number	Function	Description	Interface Schematic
1	RFIN1	This pin is DC coupled. An off chip DC blocking capacitor is required.	RFOUT1
8	RFOUT1	RF output and DC Bias (Vcc1) for the output stage.	
2, 3, 6, 7	N/C	No connection. These pins may be connected to RF ground. Performance will not be affected.	
4	RFIN2	This pin is DC coupled. An off chip DC blocking capacitor is required.	RFOUT2
5	RFOUT2	RF output and DC Bias (Vcc2) for the output stage.	
Ground Paddle	GND	Ground paddle must be connected to RF/DC ground.	

9

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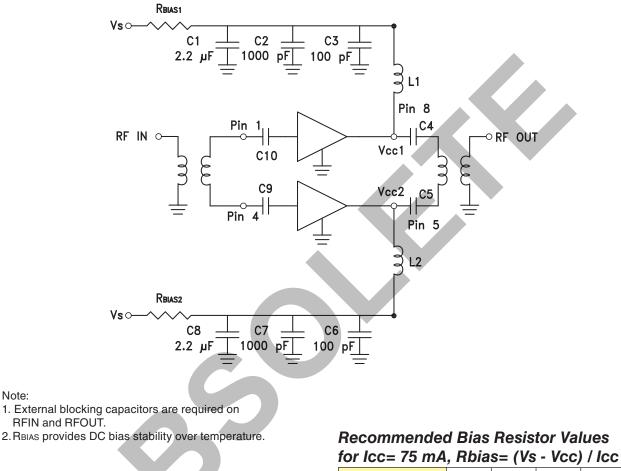


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Application Circuit for Balanced Operation



	,	0- (10		1100
Supply Voltage (Vs)	6V	8V	10V	12V
RBIAS VALUE	11 Ω	39 Ω	62 Ω	91 Ω
RBIAS POWER RATING	1/4 W	1/2 W	1/2 W	1 W

Recommended Component Values for Key Application Frequencies

Component	Frequency (MHz)						
Component	50	900	1900	2200	2400	3500	5000
L1, L2	270 nH	56 nH	18 nH	18 nH	15 nH	8.2 nH	6.8 nH
C4, C5, C9, C10	0.01 µF	100 pF					

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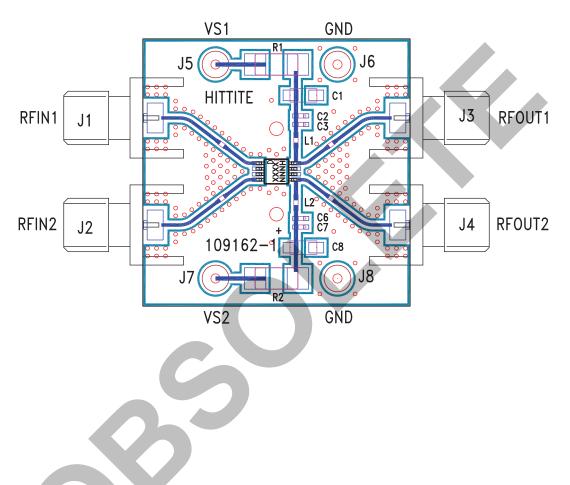


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Evaluation PCB



List of Materials for Evaluation PCB 109185^[1]

Item	Description		
J1 - J4	PCB Mount SMA Connector		
J5 - J8	DC Pins		
L1, L2	Inductor, 0402 Pkg.		
C1, C8	2.2 µF Capacitor, Tantalum		
C2, C7	1000 pF Capacitor, 0402 Pkg.		
C3, C6	100 pF Capacitor, 0402 Pkg.		
C4, C5, C9, C10	Capacitor, 0402 Pkg.		
R1, R2	Resistor, 2010 Pkg.		
U1	HMC471MS8G / HMC471MS8GE		
PCB [2]	109162 Evaluation PCB		

[1] Reference this number when ordering complete evaluation PCB

[2] Circuit Board Material: Rogers 4350

The circuit board used in the final application should use RF circuit design techniques. Signal lines should have 50 ohm impedance while the package ground leads and package bottom should be connected directly to the ground plane similar to that shown. A sufficient number of via holes should be used to connect the top and bottom ground planes. The evaluation board should be mounted to an appropriate heat sink. The evaluation circuit board shown is available from Hittite upon request.

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